

Amendment To The Specification

Please replace the paragraph on page 3, lines 5 to 12, with the following amended paragraph:

Japanese Patent Applicant Laid-Open No. 241533 9/241533 discloses a photocurable putty used in an automobile repair, containing bisphenol A type epoxy di(meth)acrylate and capable of forming a cured coating film by a photopolymerization reaction (Patent Reference 2). However, a satisfactory curing can not be achieved by photo-curing only, resulting in unsatisfactory properties in finish properties and corrosion resistance.